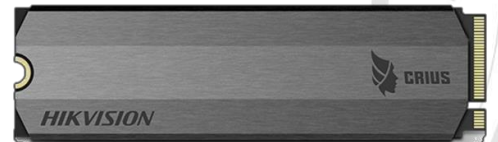


## Consumer SSD E2000 Series

### Introduction

Consumer SSD E2000 adopts M.2 interface, advanced SSD control computing chip and 3D NAND flash to effectively improve R/W speed and ensure data security.

It applies to personal computer and small-size proxy server to providing stable and high-speed service. It can also improve the high-end gaming experience and 3D graphics editing performance.



### Available Models

HS-SSD-E2000	256GB
HS-SSD-E2000	512GB
HS-SSD-E2000	1024GB
HS-SSD-E2000	2048GB

### Typical Application

- PC (notebook and desktop)
- Small-size proxy server

### Features and Functions

- **High R/W Speed**  
Supports PCIe and NVMe  
Max. read speed up to 3500 MB/s
- **3D NAND**  
Adopts 3D NAND flash to optimize capacity, performance and stability
- **Shockproof**  
No mechanical structure  
Adopts electronic chips control  
High data security
- **M.2 Interface**



## Specifications

Model		HS-SSD-E2000			
Capacity		256 GB	512 GB	1024 GB	2048GB
Form Factor		M.2 (NGFF)			
Interface		PCIe Gen 3 x 4, NVMe			
DRAM Cache Memory		support			
Dimensions		80.15 mm × 22.15 mm × 2.38 mm			
Max. sequential 128 K read speed <sup>①</sup>		3100 MB/s	3300 MB/s	3500 MB/s	3500 MB/s
Max. sequential 128 K write speed		1300 MB/s	2100 MB/s	3000 MB/s	3000 MB/s
Max. random 4 K read IOPS <sup>②</sup>		187 K	369 K	600 K	500 K
Max. random 4 K write IOPS		245 K	470 K	600 K	513 K
Power consumption <sup>③</sup>	Read (RMS max.)	6.4 W	7 W	7.2 W	5.9 W
	Write (RMS max.)	3.9 W	5 W	6.1 W	6.1 W
Endurance (TBW) <sup>④</sup>		380 TB	800 TB	1665 TB	3300 TB
NAND flash memory		3D TLC			
Weight		≤ 8 g			
MTBF (Mean Time between Failures) <sup>⑤</sup>		1,500,000 h			
Operation temperature		0 °C to 70 °C (32 °F to 158 °F)			
Storage temperature		-40 °C to +85 °C (-40 °F to +185 °F)			
Operation humidity		5% to 95% (no condensation)			
Limited warranty period		3 years			

\*: Performance test is performed in a specific testing environment. Any change of computer system, operation system, hardware, software, or functions will influence the test result.

① ②: Performance in the specifications is tested based on CrystalDiskMark.

③: Power consumption may differ according to flash configuration and platform. Power consumptions are measured by using CrystalDiskMark 1000 MB to test sequential R/W 5 times. Power consumptions are measured when sequential Read [1/5] to [5/5] and sequential Write [1/5] to [5/5].

④: The TBW value is calculated based on Workload of JEDC 218B/219A standard.

⑤: The MTBF value is calculated based on the functional failure rate of JEDC 218B/219A standard.

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Headquarters  
Room 307, Unit B, Building 2,  
399 Danfeng Road, Binjiang District,  
Hangzhou, Zhejiang, China